FIG.1

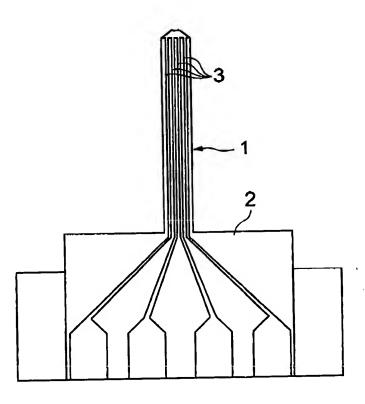


FIG.2A

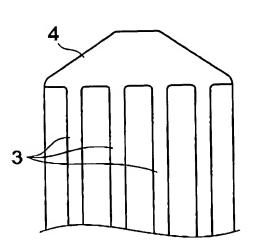
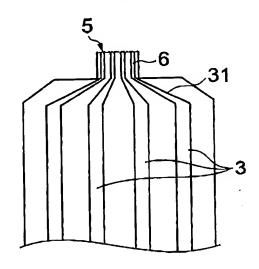


FIG.2B



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FIG.3

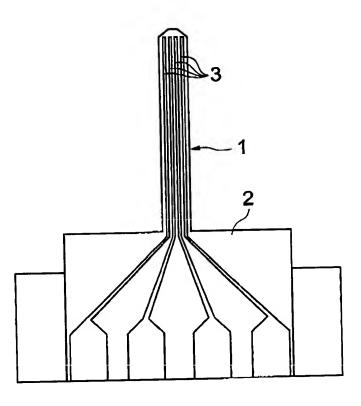
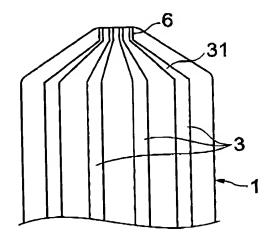


FIG.4A

3

FIG.4B



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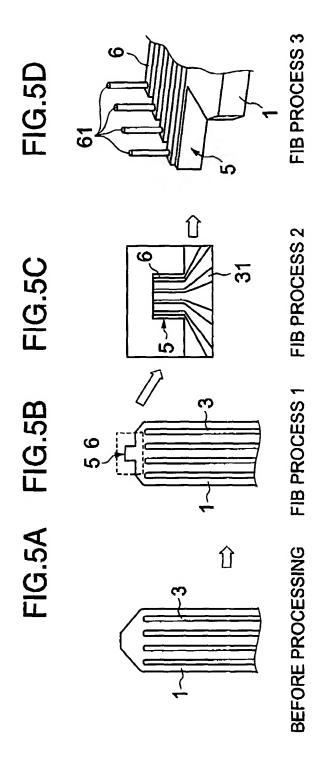


FIG.6A

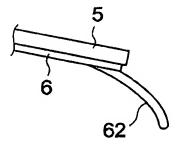


FIG.6B



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FIG.7A

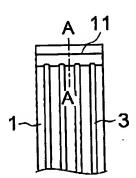


FIG.7D

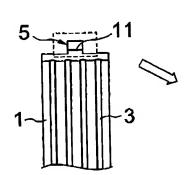


FIG.7F

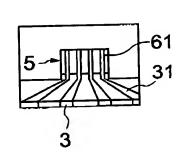
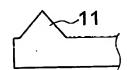
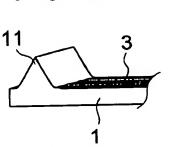


FIG.7B



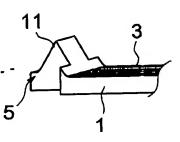
A-A' CROSS-SECTION

FIG.7C

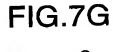


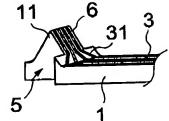
BEFORE PROCESSING

FIG.7E



FIB PROCESS 1

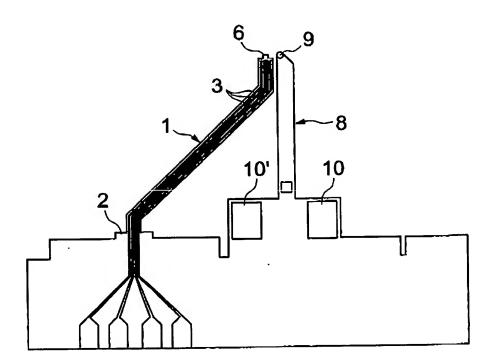


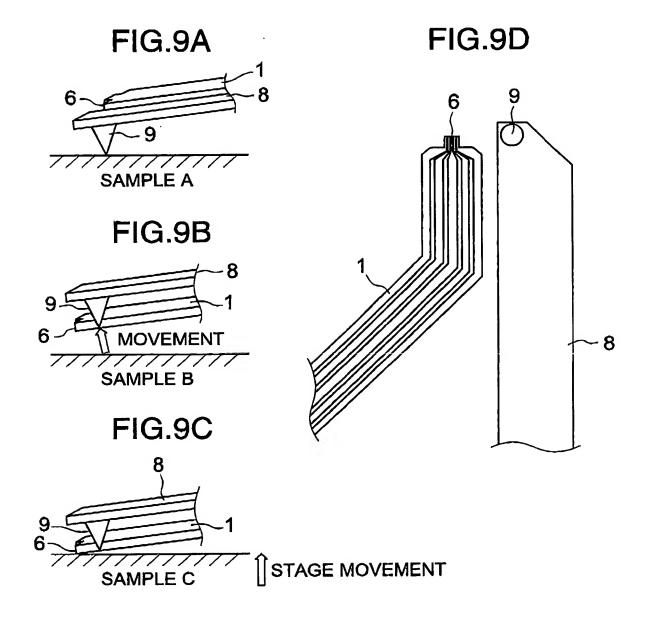


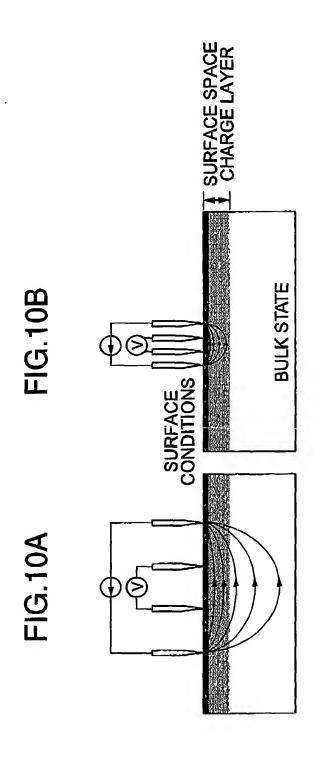
⇒ FIB PROCES\$ 2

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FIG.8







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発信: セイコーインスツルメンツ (株) 知的財産部

FIG.11

